



# CEP15N60SA/CEB15N60SA CEF15N60SA

## N-Channel Enhancement Mode Field Effect Transistor

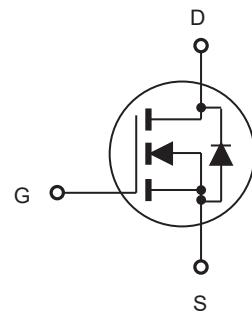
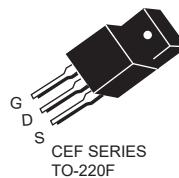
### FEATURES

Type	$V_{DSS}@T_J \text{ max}$	$R_{DS(\text{ON})}$	$I_D$	@ $V_{GS}$
CEP15N60SA	650V	0.28Ω	15A	10V
CEB15N60SA	650V	0.28Ω	15A	10V
CEF15N60SA	650V	0.28Ω	15A <sup>d</sup>	10V

■ Super high dense cell design for extremely low  $R_{DS(\text{ON})}$ .

■ High power and current handing capability.

■ RoHS compliant.



### ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Limit		Units
		TO-220/263	TO-220F	
Drain-Source Voltage	$V_{DS}$	600		V
Gate-Source Voltage	$V_{GS}$	$\pm 30$		V
Drain Current-Continuous @ $T_C = 25^\circ\text{C}$ @ $T_C = 100^\circ\text{C}$	$I_D$	15	15 <sup>d</sup>	A
		9.6	9.6 <sup>d</sup>	A
Drain Current-Pulsed <sup>a</sup>	$I_{DM}$ <sup>e</sup>	60	60 <sup>d</sup>	A
Maximum Power Dissipation @ $T_C = 25^\circ\text{C}$ - Derate above 25°C	$P_D$	160	48	W
		1.28	0.38	W/°C
Single Pulsed Avalanche Energy <sup>h</sup>	$E_{AS}$	400		mJ
Single Pulsed Avalanche Current <sup>h</sup>	$I_{AS}$	4		A
Operating and Store Temperature Range	$T_J, T_{stg}$	-55 to 150		°C

### Thermal Characteristics

Parameter	Symbol	Limit		Units
Thermal Resistance, Junction-to-Case	$R_{JC}$	0.78	2.6	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{JA}$	62.5	65	°C/W



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## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Test Condition	Min	Typ	Max	Units	
<b>Off Characteristics</b>							
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_{\text{D}} = 250\mu\text{A}$	600			V	
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 600\text{V}, V_{\text{GS}} = 0\text{V}$			1	$\mu\text{A}$	
Gate Body Leakage Current, Forward	$I_{\text{GSSF}}$	$V_{\text{GS}} = 30\text{V}, V_{\text{DS}} = 0\text{V}$			100	nA	
Gate Body Leakage Current, Reverse	$I_{\text{GSSR}}$	$V_{\text{GS}} = -30\text{V}, V_{\text{DS}} = 0\text{V}$			-100	nA	
<b>On Characteristics<sup>b</sup></b>							
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{GS}} = V_{\text{DS}}, I_{\text{D}} = 250\mu\text{A}$	2.5		4.5	V	
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_{\text{D}} = 7.5\text{A}$		0.24	0.28	$\Omega$	
<b>Dynamic Characteristics<sup>c</sup></b>							
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}} = 150\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0 \text{ MHz}$		870		pF	
Output Capacitance	$C_{\text{oss}}$			65		pF	
Reverse Transfer Capacitance	$C_{\text{rss}}$			10		pF	
<b>Switching Characteristics<sup>c</sup></b>							
Turn-On Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 400\text{V}, I_{\text{D}} = 7.5\text{A}, V_{\text{GS}} = 15\text{V}, R_{\text{GEN}} = 10\Omega$		26		ns	
Turn-On Rise Time	$t_r$			7		ns	
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$			82		ns	
Turn-Off Fall Time	$t_f$			10		ns	
Total Gate Charge	$Q_g$	$V_{\text{DS}} = 400\text{V}, I_{\text{D}} = 1\text{A}, V_{\text{GS}} = 10\text{V}$		25		nC	
Gate-Source Charge	$Q_{\text{gs}}$			4		nC	
Gate-Drain Charge	$Q_{\text{gd}}$			12		nC	
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>							
Drain-Source Diode Forward Current	$I_s$ <sup>f</sup>				15	A	
Drain-Source Diode Forward Voltage <sup>b</sup>	$V_{\text{SD}}$	$V_{\text{GS}} = 0\text{V}, I_s = 7.5\text{A}$ <sup>g</sup>			1.2	V	
Reverse Recovery Time	$T_{\text{rr}}$	$I_F = 7.5\text{A}, dI/dt = 100\text{A/us}$		253		ns	
Reverse Recovery Charge	$Q_{\text{rr}}$			2.71		uC	
Peak Reverse Recovery Current	$I_{\text{rr}}$			17.7		A	
<b>Notes :</b>							
a.Repetitive Rating : Pulse width limited by maximum junction temperature .							
b.Pulse Test : Pulse Width $\leq 300\mu\text{s}$ , Duty Cycle $\leq 2\%$ .							
c.Guaranteed by design, not subject to production testing.							
d.Limited only by maximum temperature allowed .							
e.Pulse width limited by safe operating area .							
f.Full package $I_{\text{S}(\text{max})} = 8.3\text{A}$ .							
g.Full package $V_{\text{SD}}$ , test condition $I_s = 8.3\text{A}$ .							
h. $L = 50\text{mH}, I_{\text{AS}} = 4\text{A}, V_{\text{DD}} = 50\text{V}, R_G = 25\Omega$ , Starting $T_J = 25^\circ\text{C}$ .							



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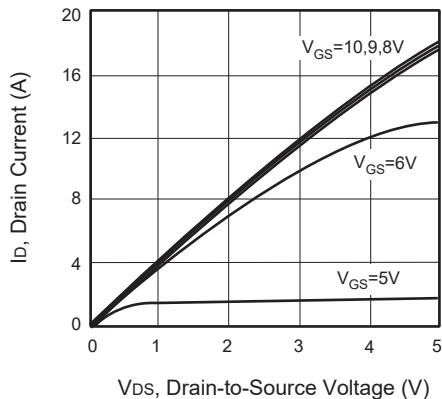


Figure 1. Output Characteristics

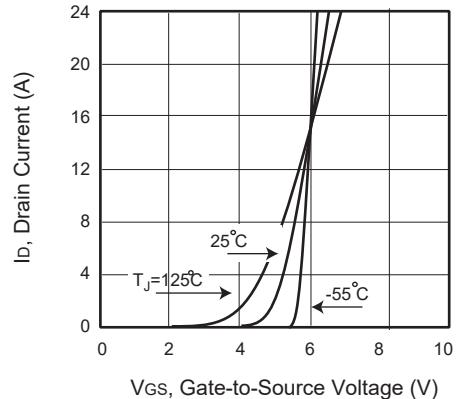


Figure 2. Transfer Characteristics

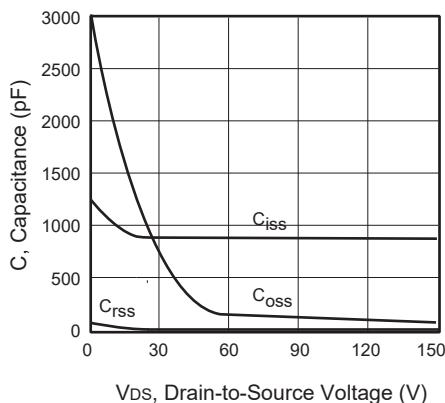


Figure 3. Capacitance

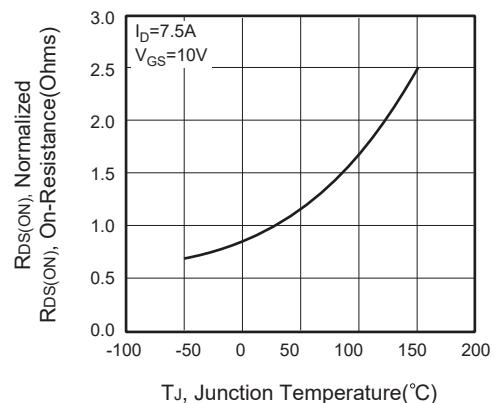


Figure 4. On-Resistance Variation with Temperature

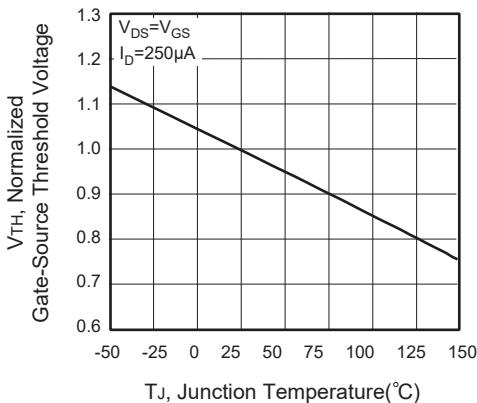


Figure 5. Gate Threshold Variation with Temperature

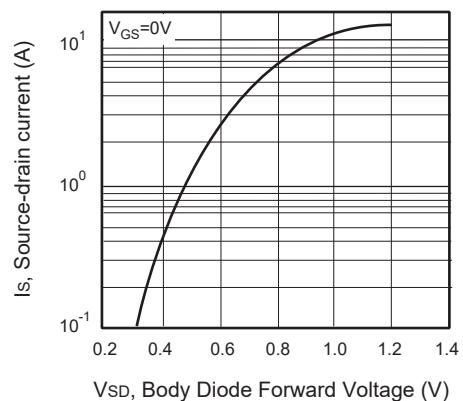


Figure 6. Body Diode Forward Voltage Variation with Source Current



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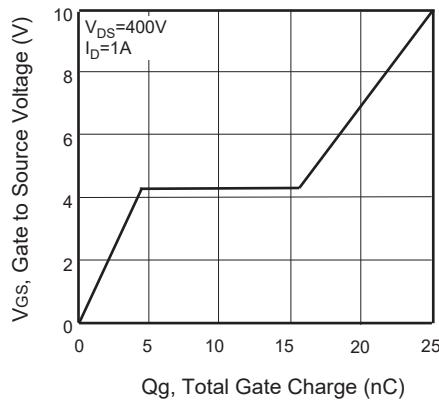


Figure 7. Gate Charge

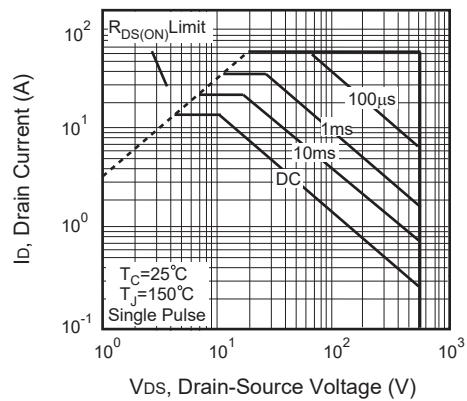


Figure 8. Maximum Safe Operating Area

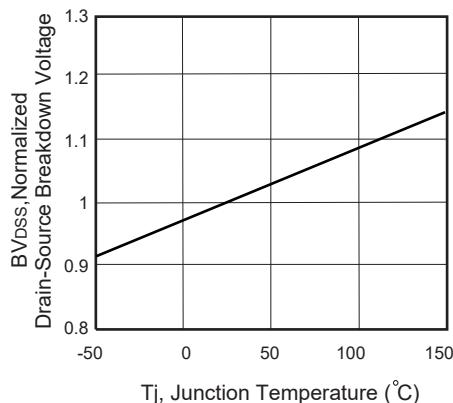


Figure 9. Breakdown Voltage Variation VS Temperature

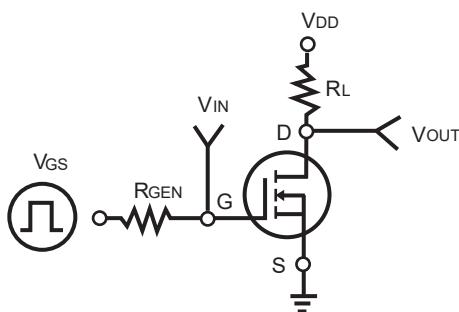


Figure 10. Switching Test Circuit

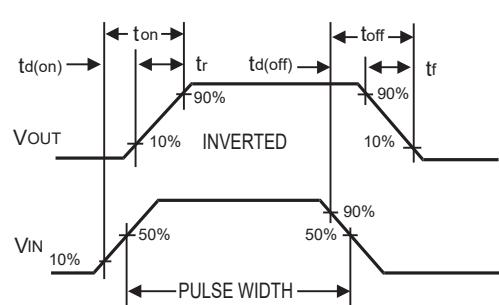


Figure 11. Switching Waveforms



# CEP15N60SA/CEB15N60SA CEF15N60SA

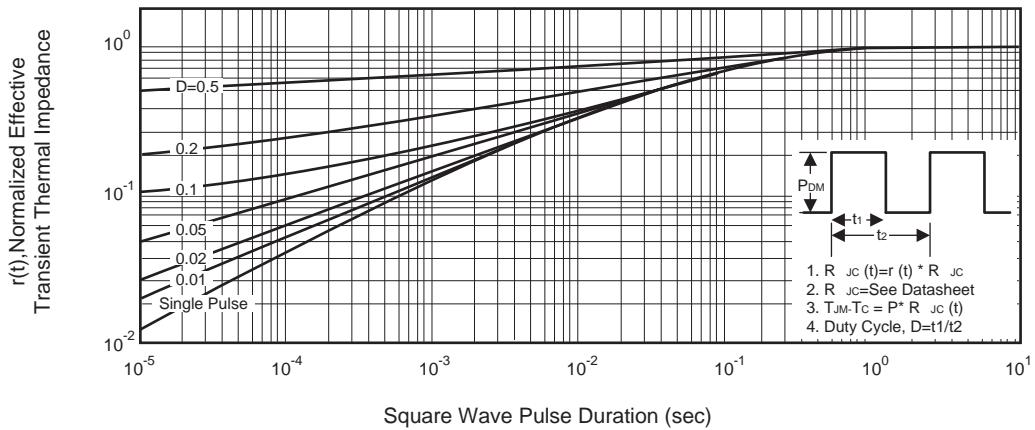


Figure 12. Normalized Thermal Transient Impedance Curve